

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
SUSUMU TAKADA	09/24/2014
EMI KURASEKO	09/24/2014
MOTOYUKI SUZUKI	09/25/2014
RECEIVING PARTY DATA	
Name:	TORAY INDUSTRIES, INC.
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Internal Address:	CHUO-KU
City:	TOKYO
State/Country:	JAPAN
Postal Code:	103-8666
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14395151
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ATTORNEY DOCKET NUMBER:	TIP-14-2391 (308877-491)
NAME OF SUBMITTER:	LESLIE J. HOOD
SIGNATURE:	/LJH/
DATE SIGNED:	10/17/2014
Total Attachments: 1	
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ASSIGNMENT

WHEREAS, we, Susumu Takada, Emi Kuraseko and Motoyuki Suzuki, all citizens of Japan, all residing at Toray Industries, Inc., 1-1, Nihonbashi-Muromachi 2-chome, Chuo-ku, Tokyo 1038666 Japan, (hereinafter referred to as "the undersigned"), having made an invention entitled METHOD FOR PRODUCING CRYSTALLINE SUBSTRATE HAVING CONCAVE-CONVEX STRUCTURE, identified in International Application No. PCT/JP2012/070362, and in US Application No. 14/395,151 (DLA Piper is authorized to insert the Serial No. when known),

WHEREAS, Toray Industries, Inc., with offices located at Intellectual Property Department, 1-1, Nihonbashi-Muromachi 2-chome, Chuo-ku, Tokyo 1038666 Japan (hereinafter referred to as "the assignee"), is desirous of acquiring the entire right, title and interest in said invention, said US application and all letters patent issuing for said invention,

NOW, THEREFORE, in consideration of One Dollar (\$1.00) and of other good and valuable consideration, receipt of which is hereby acknowledged, the undersigned, intending to be legally bound, do hereby sell, assign and transfer to the assignee the entire right, title and interest, for the United States of America, its territories and possessions, and for all foreign countries, in said invention, including said US application, all divisions and continuations thereof, all rights to claim priority based thereon, all rights to file foreign applications on said invention, and all letters patent and reissues thereof, issuing for said invention in the United States of America and in any and all foreign countries.

It is agreed that the undersigned shall be legally bound, upon request of the assignee, or its successors or assigns or a legal representative thereof, to supply all information and evidence of which the undersigned has knowledge or possession, relating to the making and practice of said invention, to testify in any legal proceeding relating thereto, to execute all instruments proper to patent the invention in the United States of America and foreign countries in the name of the assignee, and to execute all instruments proper to carry out the intent of this instrument. If the undersigned includes more than one individual, these obligations shall apply to all of the undersigned both individually and collectively.

The rights and property herein conveyed by the undersigned are free and clear of any encumbrance.

EXECUTED on the date(s) set forth below.

Sep. 24. 2014
Date

Sep. 24. 2014
Date

Sep. 25. 2014
Date

Susumu Takada
Susumu Takada

Emi Kuraseko
Emi Kuraseko

Motoyuki Suzuki
Motoyuki Suzuki